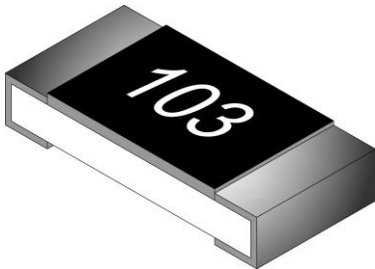




HR Series Thick Film–High Voltage Chip
Resistor Product Specifications

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■ High Voltage Chip Resistor — HR Series (Thick Film)



■ Application

- Power supply, Industrial control system
- Measurement instrument
- Back light inverter
- Medical, Precision equipment's

■ Features

- Special material and design for high working voltage require
- Meet IEC62368 standard (0805 100K~27M , 1206 75K~27M , 2512 75K27M).

■ Parts Number Explanation

Example:

HR	2010	F	1M00	E	04	Z
Product Type	Size (Inch)	Resistor Tolerance	Resistor Value	Package	Quantity	Optional
HR	0402 0603 0805 1206 1210 2010 2512	D : ±0.5% F : ±1% J : ±5%	100R=100R 1K=1K00 1M=1M00	P : Paper Taping (0603~1210) Q : Paper Taping (0402) E : Embossed Taping	04 : 4000PCS 05 : 5000PCS 10 : 10000PCS 40 : 40000PCS 50 : 50000PCS	Z : TYPE-1 NORMAL TYPE U : TYPE-2 SUPER TYPE



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■ Standard Electrical Specifications

Type-1	Rated Power At 70℃	Max. Working Voltage	Max. Over Load Voltage	T.C.R (ppm/℃)	Resistance Range		
					D: ±0.5%	J : ±5%	F : ±1%
HR0402	0.063W	100V	200V	±100	-	100Ω≤R≤10MΩ	
HR0603	0.1W	350 V	500 V	±100	-	47Ω≤R≤10MΩ	
				±200	-	10MΩ<R≤30MΩ	
HR0805	0.125 W	400 V	800 V	±100	100KΩ≤R≤1MΩ	47Ω≤R≤10MΩ	
				±200	-	10MΩ<R≤30MΩ	
HR1206	0.25 W	500 V	1000 V	±100	100KΩ≤R≤2MΩ	47Ω≤R≤10MΩ	
				±200	-	10MΩ<R≤30MΩ	
HR1210	0.33 W			±100	100KΩ≤R≤1MΩ	47Ω≤R≤10MΩ	
				±200	-	10MΩ<R≤30MΩ	
HR2010	0.5 W			±100	100KΩ≤R≤1MΩ	47Ω≤R≤10MΩ	
				±200	-	10MΩ<R≤30MΩ	
HR2512	1.0 W			±100	43KΩ≤R≤1MΩ	47Ω≤R≤10MΩ	
				±200	-	10MΩ<R≤30MΩ	

Type-2	Rated Power At 70℃	Max. Working Voltage (DC)	Max. Over Load Voltage (DC)	T.C.R (ppm/℃)	Resistance Range		
					D: ±0.5%	J : ±5%	F : ±1%
HR1206	0.25	800 V	1000 V	±100	$100K\Omega \leq R \leq 2M\Omega$	$100K\Omega \leq R \leq 10M\Omega$	
HR1210	0.33	800 V	1000 V	±100	$100K\Omega \leq R \leq 2M\Omega$		
HR2010	0.5 W	2000 V	3000 V	±100	$100K\Omega \leq R \leq 1M\Omega$		
HR2512	1.0 W	3000 V	4000 V	±100	$43K\Omega \leq R \leq 1M\Omega$		

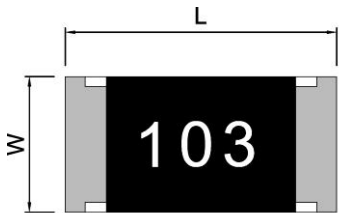
- For non-standard parts, please contact our sales dept.
- Operating Temperature Range : -55℃ ~ +155℃.



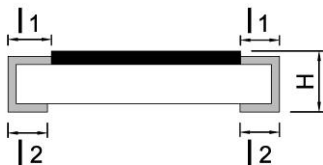
HR Series Thick Film–High Voltage Chip
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■ Type Dimension



HR0402 / HR0603 / HR0805 / HR1206 /
HR1210 / HR2010 / HR2512



■ Dimension

Unit: mm

Type-1	L	W	H	l ₁	l ₂
HR0402	1.00 ± 0.05	0.50 ± 0.05	0.30 ± 0.05	0.15 ± 0.10	0.20 ± 0.10
HR0603	1.60 ± 0.10	0.80 ± 0.10	0.40 ± 0.10	0.30 ± 0.20	0.30 ± 0.10
HR0805	2.00 ± 0.10	1.25 ± 0.10	0.50 ± 0.15	0.30 ± 0.15	0.40 ± 0.15
HR1206	3.05 ± 0.10	1.60 ± 0.10	0.55 ± 0.15	0.40 ± 0.20	0.50 ± 0.20
HR1210	3.05 ± 0.10	2.50 ± 0.15	0.55 ± 0.15	0.50 ± 0.20	0.50 ± 0.20
HR2010	5.00 ± 0.20	2.50 ± 0.15	0.55 ± 0.10	0.60 ± 0.20	0.60 ± 0.20
HR2512	6.30 ± 0.20	3.20 ± 0.15	0.55 ± 0.10	0.60 ± 0.20	0.60 ± 0.20

■ Dimension

Unit: mm

Type-2	L	W	H	l ₁	l ₂
HR1206	3.05 ± 0.10	1.60 ± 0.10	0.55 ± 0.15	0.30 ± 0.20	0.60 ± 0.20
HR1210	3.05 ± 0.10	2.50 ± 0.15	0.55 ± 0.15	0.30 ± 0.20	0.60 ± 0.20
HR2010	5.00 ± 0.20	2.50 ± 0.15	0.55 ± 0.10	0.40 ± 0.20	0.60 ± 0.20
HR2512	6.30 ± 0.20	3.20 ± 0.15	0.55 ± 0.10	0.40 ± 0.20	0.60 ± 0.20



HR Series Thick Film–High Voltage Chip Resistor Product Specifications

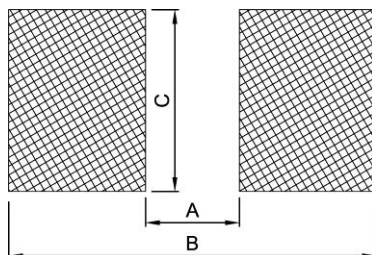
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● General Information

■ Recommend Land Pattern Design



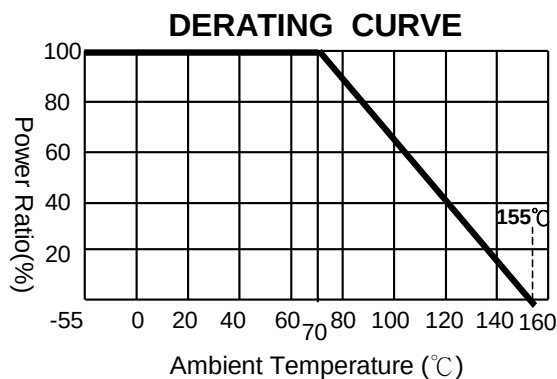
■ Dimension

Unit: mm

Type	0402	0603	0805	1206	1210	2010	2512
Item							
A	0.60	1.00	1.20	2.20	2.20	3.80	4.80
B	1.90	3.05	4.10	5.10	5.10	6.90	8.20
C	0.70	1.20	1.70	2.00	2.90	2.90	3.65

■ Performance Characteristics

■ Power Derating Curve



Power rating or current rating is in the case based on continuous full-load at ambient temperature of 70°C.

For operation at ambient temperature in excess of 70°C, the load should be derated in accordance with figure of derating Curve.

■ Voltage Rating or Current Rating

Resistance Range: $\geq 1\Omega$

Rated Voltage: The resistor shall have a DC continuous working voltage or a RMS AC continuous working voltage at commercial-line frequency and wave form corresponding to the power rating, as determined formula as following:

$$E(RCWV) = \sqrt{P \times R}$$

E=Rated voltage(V)

P=Power rating(W)

R=Nominal resistance(Ω)



HR Series Thick Film–High Voltage Chip Resistor Product Specifications

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● Reliability Test and Requirement

Test Item	Test Method	Procedure	Requirements	
			Type-1	Type-2
Temperature Coefficient of Resistance (T.C.R)	JIS-C-5201-1 4.8 IEC-60115-1 4.8	At 25℃ / -55℃ and 25℃ /+155℃, 25℃ is the reference temperature	As Spec	
Short Time Overload	JIS-C-5201-1 4.13 IEC-60115-1 4.13	2.5 times RCWV or Max. Overload voltage whichever is less for 5 seconds.	1% and below : ±(1.0%+0.05Ω) 5% : ±(2.0%+0.1Ω)	±2.0%
Leaching	JIS-C-5201-1 4.18 IEC-60068-2-58 8.2.1	260±5℃ for 30 seconds.	Individual leaching area ≤5% Total leaching area ≤ 10%	
Resistance to Soldering Heat	JIS-C-5201-1 4.18 IEC-60115-1 4.18	260±5℃ for 10 seconds.	1% and below : ±(0.5%+0.05Ω) 5% : ±(1.0%+0.05Ω)	±1.0%
Rapid Change of Temperature	JIS-C-5201-1 4.19 IEC-60115-1 4.19	-55℃ to +155℃, 5 cycles	1% and below : ±(0.5%+0.05Ω) 5% : ±(1.0%+0.10Ω)	±1.0%
Resistance to Solvent	JIS-C-5201-1 4.29	The tested resistor be immersed into isopropyl alcohol of 20~25℃ for 60 secs. Then the resistor is left in the room for 48 hrs.	1% and below : ±(0.5%+0.05Ω) 5% : ±(0.5%+0.05Ω)	±1.0%
Damp Heat with Load	JIS-C-5201-1 4.24 IEC-60115-1 4.24	40±2℃, 90~95% R.H. RCWV or Max. working voltage whichever is less for 1000 hrs with 1.5 hrs "ON" and 0.5 hrs "OFF" .	1% and below : ±(1.0%+0.05Ω) 5% : ±(2.0%+0.05Ω)	±3.0%
Load Life (Endurance)	JIS-C-5201-1 4.25 IEC-60115-1 4.25.1	70±2℃, RCWV or Max. working voltage whichever is less for 1000 hrs with 1.5 hrs "ON" and 0.5 hr "OFF" .	1% and below : ±(1.0%+0.05Ω) 5% : ±(3.0%+0.10Ω)	±3.0%
Insulation Resistance	JJIS-C-5201-1 4.6 IEC-60115-1 4.6	Apply 100VDC for 1 minute.	≥ 10GΩ	
Bending Strength	JIS-C-5201-1 4.33 IEC-60115-1 4.33	Bending once for 5 seconds D : 0402、0603、0805=5mm 1206、1210=3mm 2010、2512=2mm	1% and below : ±(1.0%+0.05Ω) 5% : ±(1.0%+0.05Ω)	±1.0%

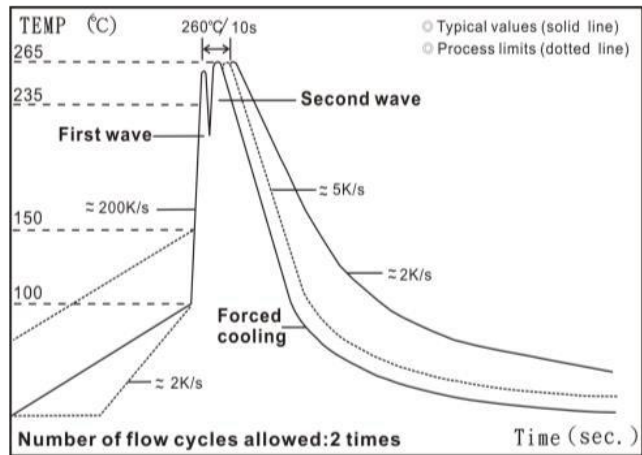


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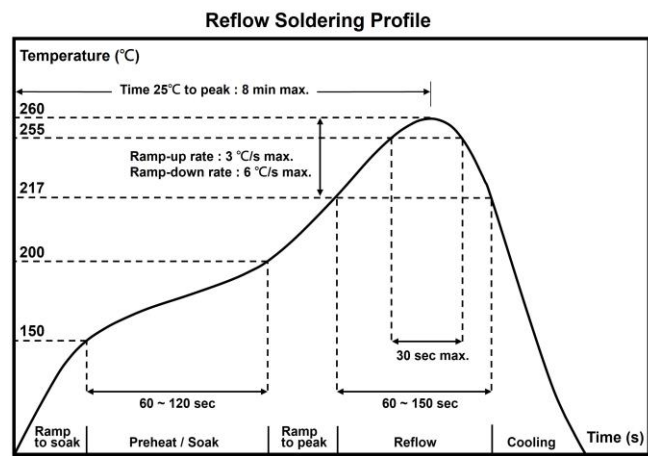
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■ Recommended Customer Soldering Parameters

■ Wave solder Temperature condition



■ Solder reflow Temperature condition



■ Rework temperature (hot air equipment) : 350°C, 3~5seconds

■ Recommended reflow methods

IR, vapor phase oven, hot air oven

If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.



HR Series Thick Film–High Voltage Chip Resistor Product Specifications

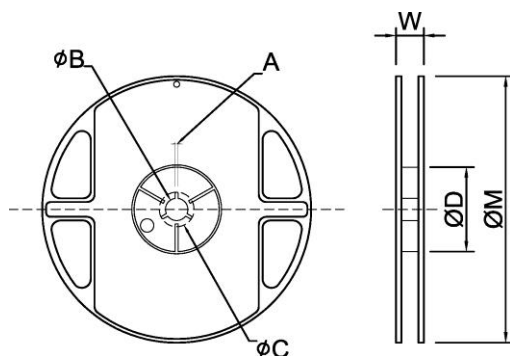
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■ Appendix For SMD Chip Resistor

● Packaging Information

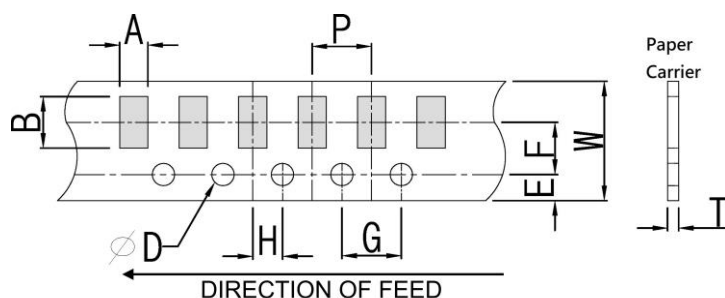


■ Dimension

Unit: mm

Type	Size		A	ΦB	ΦC	ΦD	W	ΦM
0402	7"	10K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	11.5±2.0	178±2.0
	13"	40K/50K Reel	2.0±0.5	13.5±1.0	21±1.0	100±1.0	11.5±2.0	330±2.0
0603/0805/1206/1210	7"	5K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	11.5±2.0	178±2.0
0603/0805/1206	10"	10K/Reel	2.0±0.5	13.5±1.0	21±1.0	100±1.0	11.5±2.0	254±2.0
	13"	20K/Reel	2.0±0.5	13.5±1.0	21±1.0	100±1.0	11.5±2.0	330±2.0
2010/2512	7"	4K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	16.0±2.0	178±2.0

■ Tapping Specification



■ Dimension

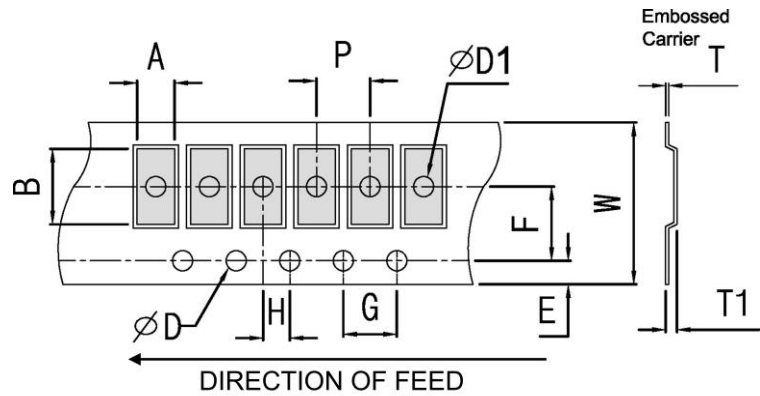
Unit: mm

Packaging	Type	A	B	W	E	F	G	H	T	ΦD	P
Paper Type	0402	0.70±0.1	1.20±0.1	8.0±0.2	1.75±0.1	3.5±0.05	4.0±0.1	2.0±0.05	0.45±0.1	1.50 ^{+0.10} ₋₀	2.0±0.1
	0603	1.05±0.2	1.80±0.2	8.0±0.2	1.75±0.1	3.5±0.05	4.0±0.1	2.0±0.05	0.60±0.1		4.0±0.1
	0805	1.55±0.2	2.30±0.2	8.0±0.2	1.75±0.1	3.5±0.05	4.0±0.1	2.0±0.05	0.75±0.1		
	1206	1.90±0.2	3.50±0.2	8.0±0.2	1.75±0.1	3.5±0.05	4.0±0.1	2.0±0.05	0.75±0.1		
	1210	2.85±0.2	3.50±0.2	8.0±0.2	1.75±0.1	3.5±0.05	4.0±0.1	2.0±0.05	0.75±0.1		



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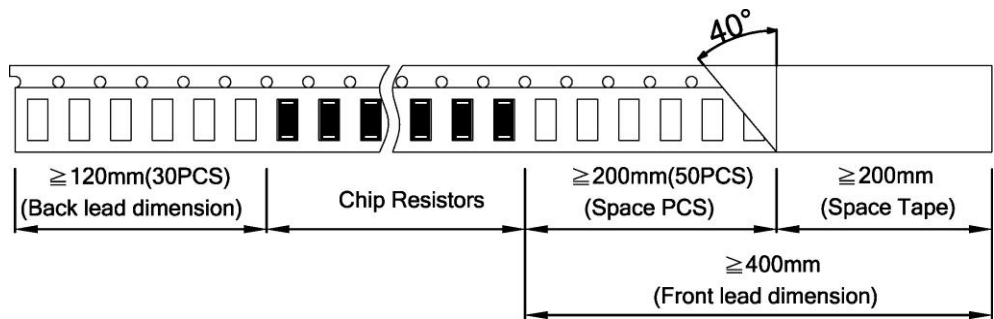


Dimension Unit: mm

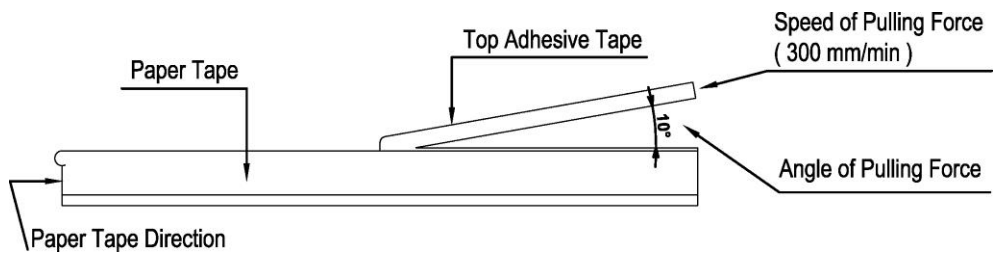
Packaging	Type	A	B	W	E	F	G	H	T	ϕD	$\psi D1$	T1	P
Embossed Type	2010	2.80±0.20	5.60±0.20	12±0.10	1.75±0.10	5.5±0.05	4.0±0.10	2.0±0.05	0.23±0.10	1.50 ^{+0.10} ₋₀	1.50±0.10	0.85±0.15	4.0±0.1
	2512	3.40±0.20	6.70±0.20	12±0.10	1.75±0.10	5.5±0.05	4.0±0.10	2.0±0.05	0.23±0.10		1.50±0.10	0.85±0.15	

Packing Material Data/Storage Data

Front & Back Lead Dimension



Top Adhesive Peel Off Strength : 10~70g



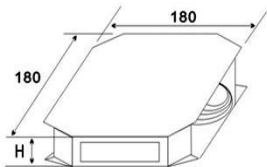


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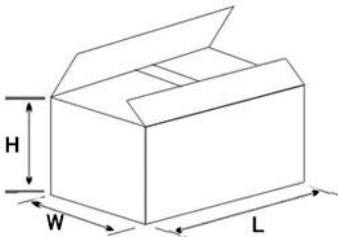
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■ Package

Inner Box Size	
Reel	Size H(mm)
1	13
2	24
3	36
5	60
10	113



External Box Size			
Contain (Kpcs)	Length (mm)	Width (mm)	Height (mm)
25K	180	180	60
50K	180	180	110
150K	430	200	200
300K	400	400	200



■ Storage Data :

Storage time at the environment temp: 25±5℃ & humidity: 60±20% is valid for two years.

■ Product Testing Method :

Our products are tested with our company's tapping & testing equipments by using four-feet probe to touch at the back of both electrodes. Supposed different testing points or methods are requested, please advise beforehand and customized-made production is available.